

# 6MBI180VB-120-55

**IGBT Modules** 

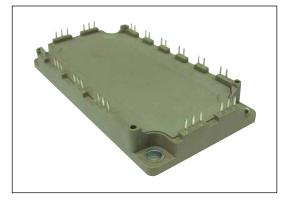
# **IGBT MODULE (V series)** 1200V / 180A / 6 in one package

## Features

**Compact Package** P.C.Board Mount Low VCE (sat)

#### Applications

Inverter for Motor Drive AC and DC Servo Drive Amplifier Uninterruptible Power Supply Industrial machines, such as welding machines



#### Maximum Ratings and Characteristics

#### ● Absolute Maximum Ratings (at Tc=25°C unless otherwise specified)

Items		Symbols	Conditions	Conditions		Units	
Collector-Emitter voltage		VCES				V	
Gate-Emitter voltage		V <sub>ges</sub>				V	
rter			Continuous	Tc=80°C	150		
Collector current			1ms	Tc=80°C	400	۸	
		-lc			150	A	
		-IC pulse	1ms		400		
Collector power dissipation		Pc	1 device		1075	W	
Junction temperature		Tj			175	°C	
Operating junciton temperature (under switching conditions)		T <sub>jop</sub>			150		
Case temperature		Tc			125		
Storage temperature		T <sub>stg</sub>			-40 ~ +125		
Isolation voltage	Between terminal and copper base (*1) Between thermistor and others (*2)	Viso	AC : 1min.	AC : 1min.		VAC	
Screw torque	Mounting (*3)	-	M5		3.5	Nm	

Note \*1: All terminals should be connected together during the test. Note \*2: Two thermistor terminals should be connected together, other terminals should be connected together and shorted to base plate during the test. Note \*3: Recommendable value : 2.5-3.5 Nm (M5)

#### • Electrical characteristics (at T<sub>j</sub>= 25°C unless otherwise specified)

	Current a la	Conditions		Characteristics			11
ems	Symbols			min.	typ.	max.	Units
Zero gate voltage collector current	t I <sub>CES</sub> V <sub>GE</sub> = 0V, V <sub>CE</sub> = 1200V		-	-	1.0	mA	
Gate-Emitter leakage current	Iges	$V_{CE} = 0V, V_{GE} = \pm 20V$		-	-	200	nA
Gate-Emitter threshold voltage	V <sub>GE (th)</sub>	V <sub>CE</sub> = 20V, I <sub>c</sub> = 200mA		6.0	6.5	7.0	V
		V <sub>GE</sub> = 15V I <sub>c</sub> = 200A	Tj=25°C	-	2.70	3.15	- V
	V <sub>CE (sat)</sub> (terminal)		Tj=125°C	-	3.05	-	
Collector Emitter acturation valtage			Tj=150°C	-	3.10	-	
Collector-Emitter saturation voltage	V <sub>CE (sat)</sub> (chip)	V <sub>GE</sub> = 15V I <sub>c</sub> = 200A	Tj=25°C	-	1.85	2.30	
			Tj=125°C	-	2.20	-	
			Tj=150°C	-	2.25	-	
Internal gate resistance	R <sub>G (int)</sub>	-		-	3.8	-	Ω
Input capacitance	Cies	V <sub>CE</sub> = 10V, V <sub>GE</sub> = 0V, f = 1MHz		-	16.5	-	nF
Input capacitance	ton	V <sub>cc</sub> = 600V		-	0.39	1.20	μs
Turn-on time	t			-	0.09	0.60	
	<b>t</b> r (i)	− Ic = 200A − V <sub>GE</sub> = +15 / -15V	-	0.03	-		
	toff	$R_{G} = 1.2\Omega$		-	0.53	1.00	
Turn-off time	tr			-	0.06	0.30	
			Tj=25°C	-	2.55	3.00	- V
	V⊧ (terminal)	IF = 200A	Tj=125°C	-	2.70	-	
<b>_</b>			Tj=150°C	-	2.65	-	
Forward on voltage	V⊧ (chip)	IF = 200A	Tj=25°C	-	1.70	2.15	
			Tj=125°C	-	1.85	-	
			Tj=150°C	-	1.80	-	
Reverse recovery time	trr	I <sub>F</sub> = 200A		-	-	0.35	μs
	R	T = 25°C		-	5000	-	Ω
Resistance		T = 100°C		465	495	520	
Resistance B value	В	T = 25 / 50°C		3305	3375	3450	K

#### • Thermal resistance characteristics

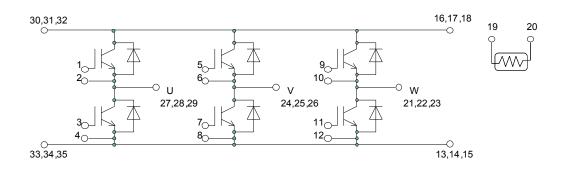
Items	Symbols	Conditions	Characteristics			Units
		Conditions	min.	typ.	max.	Units
Thermal registeres (Idevice)	R <sub>th(j-c)</sub>	Inverter IGBT	-	-	0.14	°C/W
Thermal resistance (1device)	Kth(j-c)	Inverter FWD	-	-	0.25	
Contact thermal resistance (1device) (*4)	Rth(c-f)	with Thermal Compound	-	0.05	-	

Note \*4: This is the value which is defined mounting on the additional cooling fin with thermal compound.

## Equivalent Circuit Schematic

[Inverter]

[ Thermistor ]



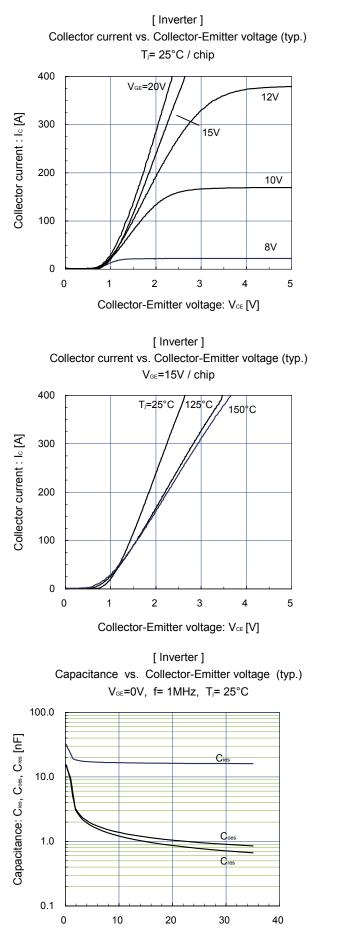
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[Inverter]

Collector current vs. Collector-Emitter voltage (typ.)

 $T_j = 150^{\circ}C / chip$ 

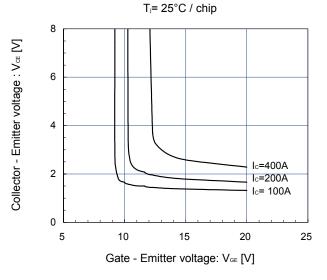
#### Characteristics (Representative)



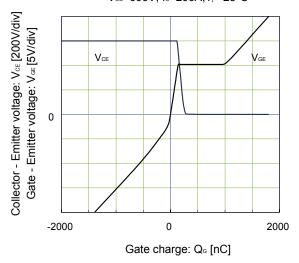
Collector - Emitter voltage: VCE [V]

V<sub>GE</sub>=20V 15V 12V Collector current : Ic [A] 300 200 10V 100 8V 0 0 1 2 3 4 5 Collector-Emitter voltage: VCE [V] [Inverter] Collector-Emitter voltage vs. Gate-Emitter voltage (typ.)

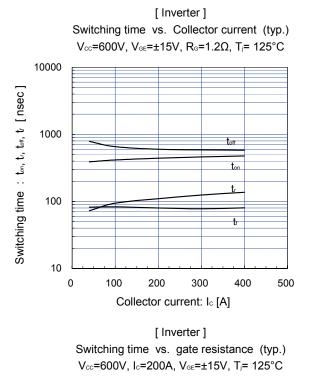
400

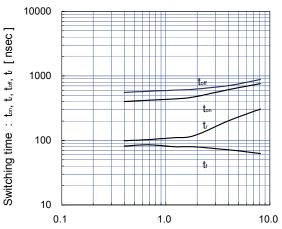


[ Inverter ] Dynamic gate charge (typ.) V<sub>cc</sub>=600V, I<sub>c</sub>=200A,T<sub>j</sub>= 25°C

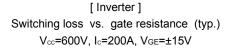


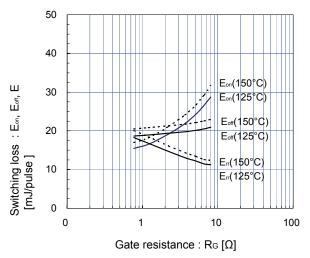
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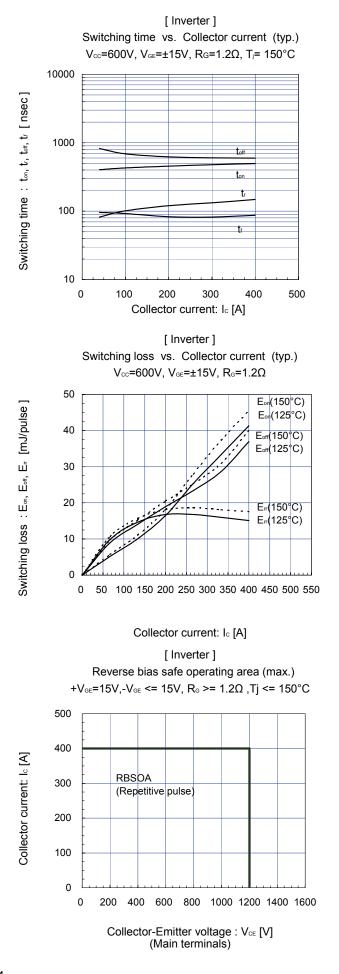




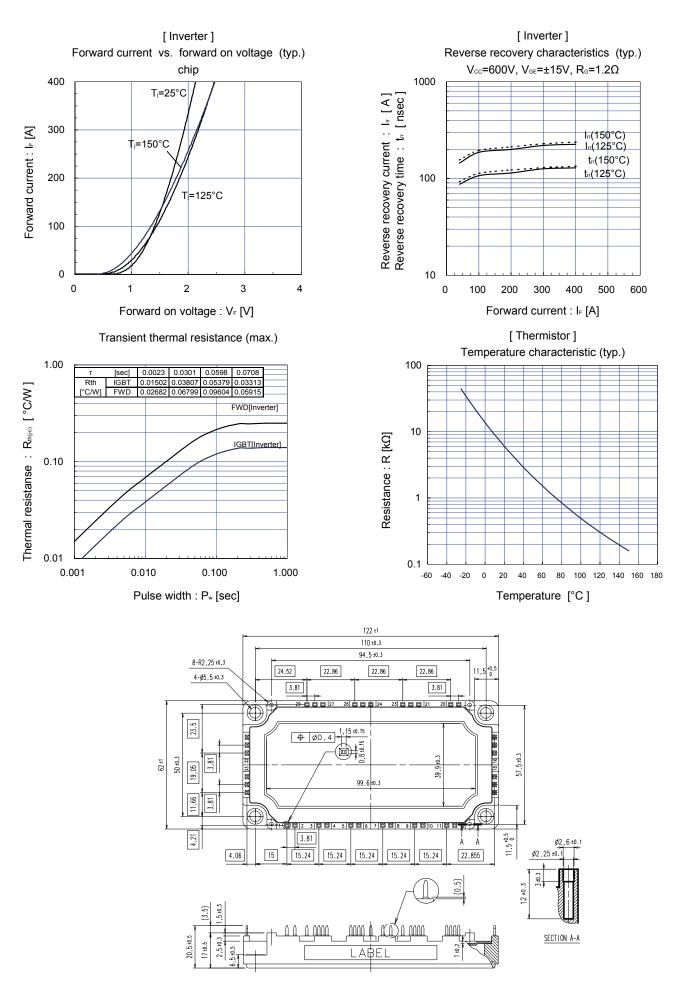
Gate resistance :  $R_G [\Omega]$ 







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